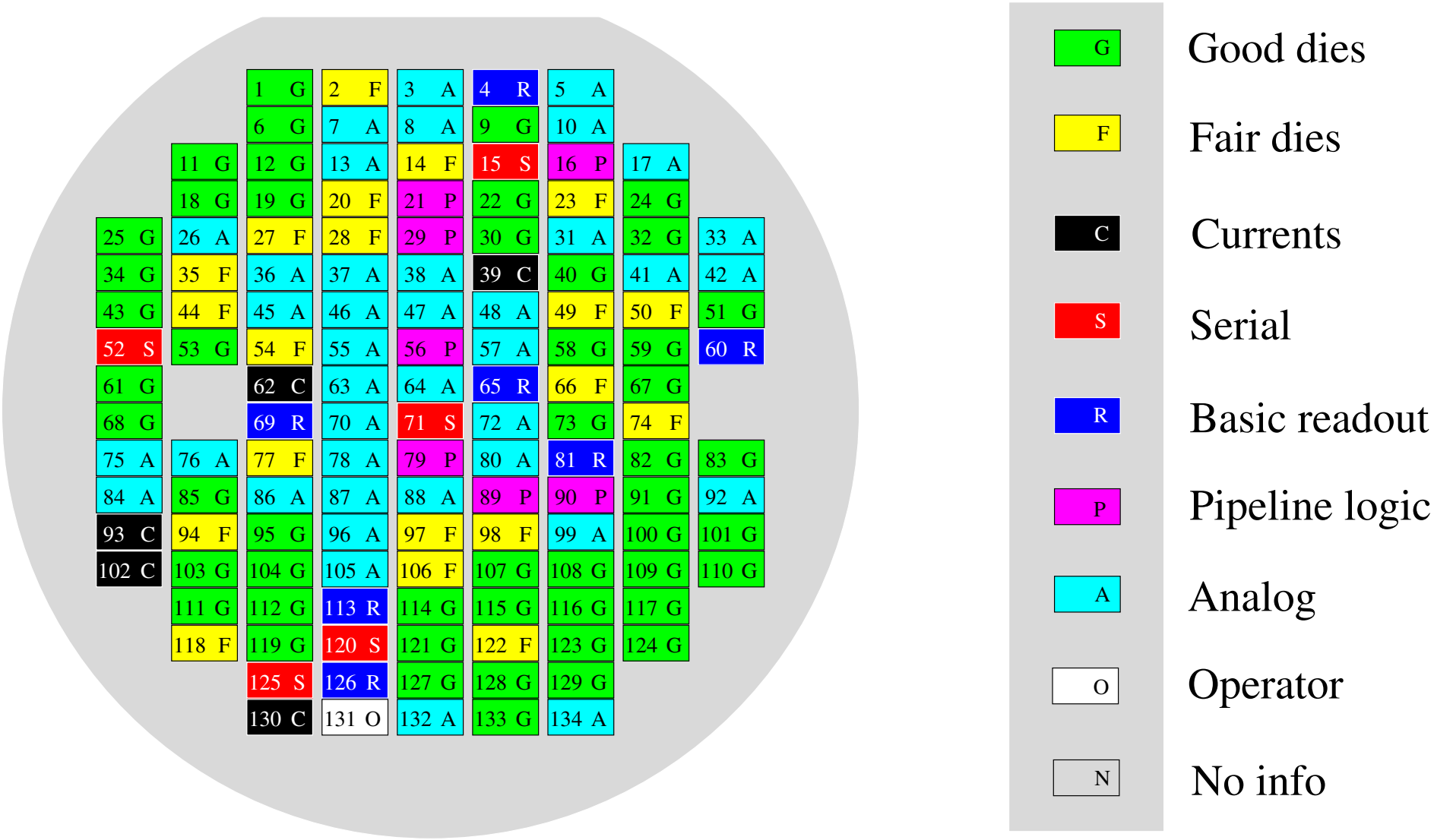
Types of die failures for wafer 166 s/n: Y21316-12-08

Date: 07/01/99